#8/C Subspec

PATENT



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Claims

In re Application of:

Venkateshwaran Vaiyapuri

Serial No.: 10/082,392

Filed: February 25, 2002

For: DUAL LOC SEMICONDUCTOR ASSEMBLY EMPLOYING FLOATING

LEAD FINGER STRUCTURE

Confirmation No.: 6993

Examiner: D. Zarneke

Group Art Unit: 2827

Attorney Docket No.: 2269-4369.1US

(99-1230.01/US)

Notice of Allowance Mailed:

June 5, 2003

NOTICE OF EXPRESS MAILING

Papress Mail Mailing Label Number: EV326922036US

Date of Deposit with USPS: September 5, 2003

Person making Deposit: Chris Haughton

AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)

Mail Stop ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

Amendments to the Title appear on page 3 of this paper.

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Amendments to the Specification appear on page 4 of this paper.

Amendments to the Abstract appear on page 5 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 6 of this paper.

Remarks begin on page 14 of this paper.